



RoHS Compliant

**MAX
260°C**

**MSL
1**



PRODUCT FAMILY	Material	CAS Number	% Normalize for BOM	Wt. Of BOM Item (g)	% by Wt (Comp. Item)	mg/unit	% by Wt Of Unit	ppm
753 20 DRT							112.20	
Alumina Ceramic	Al2O3	1344-28-1	0.8800	0.0987	87.50%	86.3940	77.00%	770000
	SiO2 (silicon dioxide)	14808-60-7			12.50%	12.3420	11.00%	110000
					100.00%	98.7360		
Conductor Thick Film	Ag	7440-22-4	0.0068	0.0008	100.00%	0.7630	0.68%	6800
					100.00%	0.7630		
Resistor Thick Film	RuO2	12036-10-1	0.0079	0.0009	30.00%	0.2659	0.24%	2370
	PbO	1317-36-8			10.00%	0.0886	0.08%	790
	SiO2 (silicon dioxide)	14808-60-7			30.00%	0.2659	0.24%	2370
	B2O3	1303-86-2			30.00%	0.2659	0.24%	2370
					100.00%	0.8864		
Notch Conductor Thick Film	Ag	7440-22-4	0.0113	0.0013	100.00%	1.2679	1.13%	11300
					100.00%	1.2679		
Underplate	Ni	7440-02-0	0.0250	0.0028	100.00%	2.8050	2.50%	25000
Finish Plate	Sn	7440-31-5	0.0170	0.0019	100.00%	1.9074	1.70%	17000
					100.00%	1.9074		
Covercoat	TiO2 Silicone	13463-67-7	0.0520	0.0058	50.00%	2.9172	2.60%	26000
		218163-11-2			50.00%	2.9172	2.60%	26000
		Sum			1.0000	0.1122	100.00%	5.8344
			part weight	0.1122				
		Totals:		0.1122		112.20	100.00%	1000000

RoHS exemption claimed for lead in glass of electronic component